## Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 40 V Forward Current - 3.0A

## FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications


## MECHANICAL DATA

- Case: SOD-123FL

1:Cathode 2:Anode
Simplified outline SOD-123FL and symbol

- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight:15mg 0.00048oz


## Absolute Maximum Ratings and Electrical characteristics

Ratings at $25^{\circ} \mathrm{C}$ ambient temperature unless otherwise specified.Single phase, half wave, 60 Hz resistive or inductive load,for capacitive load, derate by $20 \%$

| Parameter | Symbols | Values | Units |
| :---: | :---: | :---: | :---: |
| Maximum Repetitive Peak Reverse Voltage | $V_{\text {RRM }}$ | 40 | V |
| Maximum RMS voltage | $V_{\text {RMS }}$ | 28 | V |
| Maximum DC Blocking Voltage | $V_{D C}$ | 40 | V |
| Maximum Average Forward Rectified Current | $\mathrm{I}_{\text {F(AV) }}$ | 3.0 | A |
| Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method) | $I_{\text {FSM }}$ | 80 | A |
| Max Instantaneous Forward Voltage at 3 A | $V_{F}$ | 0.55 | V |
| Maximum DC Reverse Current $T_{a}=25^{\circ} \mathrm{C}$ at Rated DC Reverse Voltage $T_{a}=100^{\circ} \mathrm{C}$ | $I_{\text {R }}$ | $\begin{gathered} 0.3 \\ 5 \end{gathered}$ | mA |
| Typical Junction Capacitance ${ }^{1)}$ | $\mathrm{C}_{j}$ | 160 | pF |
| Typical Thermal Resistance ${ }^{2)}$ | $\mathrm{R}_{\theta J \mathrm{~A}}$ | 65 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating Junction Temperature Range | T ${ }^{\text {j}}$ | $-55 \sim+125$ | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | $-55 \sim+150$ | ${ }^{\circ} \mathrm{C}$ |

1) Measured at 1 MHz and applied reverse voltage of 4 V D.C.
2) P.C.B. mounted with $0.2 \times 0.2^{\prime \prime}(5 \times 5 \mathrm{~mm})$ copper pad areas.

## PMEG4030ER

Fig. 1 Forward Current Derating Curve


Fig.3 Typical Forward Characteristic


Fig. 5 Maximum Non-Repetitive Peak Forward Surage Current


Fig. 2 Typical Reverse Characteristics


Fig. 4 Typical Junction Capacitance


Flg.6- TypIcal Translent Thermal Impedance
Transient Thermal Impedance ( $\left.{ }^{\circ} \mathrm{C} / \mathrm{N}\right)$


## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads


| UNIT |  | A | C | D | E | e | $g$ | $\mathrm{H}_{\mathrm{E}}$ | $\angle$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | max | 1.1 | 0.20 | 2.9 | 1.9 | 1.1 | 0.9 | 3.8 | $7^{\circ}$ |
|  | min | 0.9 | 0.12 | 2.6 | 1.7 | 0.8 | 0.7 | 3.5 |  |
| mil | max | 43 | 7.9 | 114 | 75 | 43 | 35 | 150 |  |
|  | min | 35 | 4.7 | 102 | 67 | 31 | 28 | 138 |  |

The recommended mounting pad size


Unit: $\frac{\mathrm{mm}}{(\mathrm{mil})}$

